



Designation: D6412/D6412M – 99 (Reapproved 2020)

Standard Specification for Epoxy (Flexible) Adhesive For Bonding Metallic And Nonmetallic Materials¹

This standard is issued under the fixed designation D6412/D6412M; the number immediately following the designation indicates the year of original adoption or, in the case of revision, the year of last revision. A number in parentheses indicates the year of last reapproval. A superscript epsilon (ϵ) indicates an editorial change since the last revision or reapproval.

1. Scope

1.1 The specification covers a two-part modified epoxy paste adhesive for bonding metallic and nonmetallic materials. The adhesive should be suitable for forming bonds that can withstand environmental exposure to temperatures from -184 to 82 °C [-300 to 180 °F] when exposed to an expected combination of stress, temperature, and relative humidity to be encountered in service.

NOTE 1—When coordinated through the Department of Defense (DoD) and the National Aeronautics and Space Administration (NASA), this practice will be a direct replacement of MIL-A-82720 (OS), MIS-26872, and MSFC-SPEC-2037.

1.2 The values stated in SI units or inch-pound units are to be regarded separately as standard. Within the text, the inch-pound units are shown in brackets. The values stated in each system are not exact equivalents; therefore, each system must be used independently of the other. Combining values from the two systems may result in nonconformance with this specification.

1.3 The following precautionary statement pertains to the test method portion only, Section 8, of this specification: *This standard does not purport to address all of the safety concerns, if any, associated with its use. It is the responsibility of the user of this standard to establish appropriate safety, health, and environmental practices and determine the applicability of regulatory limitations prior to use.*

1.4 *This international standard was developed in accordance with internationally recognized principles on standardization established in the Decision on Principles for the Development of International Standards, Guides and Recommendations issued by the World Trade Organization Technical Barriers to Trade (TBT) Committee.*

¹ This specification is under the jurisdiction of ASTM Committee D14 on Adhesives and is the direct responsibility of subcommittee D14.80 on Metal Bonding Adhesives.

Current edition approved Jan. 1, 2020. Published January 2020. Originally approved in 1999. Last previous edition approved in 2012 as D6412/D6412M – 99 (2012). DOI: 10.1520/D6412_D6412M-99R20.

2. Referenced Documents

2.1 ASTM Standards:²

A109/A109M Specification for Steel, Strip, Carbon (0.25 Maximum Percent), Cold-Rolled

A167 Specification for Stainless and Heat-Resisting Chromium-Nickel Steel Plate, Sheet, and Strip (Withdrawn 2014)³

B209 Specification for Aluminum and Aluminum-Alloy Sheet and Plate

D907 Terminology of Adhesives

D1002 Test Method for Apparent Shear Strength of Single-Lap-Joint Adhesively Bonded Metal Specimens by Tension Loading (Metal-to-Metal)

D1876 Test Method for Peel Resistance of Adhesives (T-Peel Test)

D2240 Test Method for Rubber Property—Durometer Hardness

D2393 Test Method for Viscosity of Epoxy Resins and Related Components (Withdrawn 1992)³

D2651 Guide for Preparation of Metal Surfaces for Adhesive Bonding

D3951 Practice for Commercial Packaging

D4142 Guide for Testing Epoxy Resins

E595 Test Method for Total Mass Loss and Collected Volatile Condensable Materials from Outgassing in a Vacuum Environment

2.2 *National Aeronautics and Space Administration (NASA):⁴*

JSC Sp-R-0022 General Specification, Vacuum Stability Requirement of Polymeric Material for Spacecraft Application

MSFC-HDBK-527/JSC-09604 Material Selection List for Hardware Systems

² For referenced ASTM standards, visit the ASTM website, www.astm.org, or contact ASTM Customer Service at service@astm.org. For *Annual Book of ASTM Standards* volume information, refer to the standard's Document Summary page on the ASTM website.

³ The last approved version of this historical standard is referenced on www.astm.org.

⁴ Unless otherwise indicated, copies of the above documents are available from any NASA installation library or document repository.

GSFC RP 1124 Outgassing Data for Selecting Spacecraft Materials

NOTE 2—Copies of specifications, standards, drawings and publications required by suppliers in connection with specific purchases should be obtained from the purchaser or as directed by his contracting officer.

3. Terminology

3.1 *Definitions*—Many terms in this specification are defined in Terminology **D907**.

3.2 Definitions of Terms Specific to This Standard:

3.2.1 *epoxy-polyamide high viscosity adhesive, n*—an epoxy paste base (B) and a modified amide paste accelerator (A) when mixed in a proper ratio results in a viscous paste.

3.2.2 *epoxy-polyamide low viscosity adhesive, n*—an epoxy liquid base (B) and a modified amide liquid accelerator (A) when mixed in a proper ratio results in a viscous liquid.

4. Significance and Use

4.1 *General*—This specification provides testing procedures and specimen requirements to differentiate between the physical and adhesive bonding properties of two types of epoxy-polyamide adhesive.

5. Classification

5.1 The epoxy-polyamide adhesive shall be furnished as one of the following types:

5.1.1 *Type I*—Consists of two-part kits of Part B, base and Part A, accelerator.

5.1.1.1 *Grade 1*—The high viscosity adhesive system is composed of an epoxy base (B) and a modified polyamide accelerator (A).

5.1.1.2 *Grade 2*—The low viscosity adhesive system is composed of an epoxy liquid base (B) and a modified polyamide liquid accelerator (A).

5.1.2 *Type II*—Consists of premixed, frozen, Type I, Grade 1 or Type I, Grade 2.

6. Ordering Information

6.1 *Procurement Documents*—Purchasers may select any of the desired options offered herein and the procurement documents should specify the following:

6.1.1 Title, number and dated revision letter of this specification,

6.1.2 Adhesive type and grade numbers,

6.1.3 Amounts and unit quantities of adhesive required,

6.1.4 Curing conditions,

6.1.5 Level of Packaging and packing required, and

6.1.6 Whether or not qualification (see **6.2**) is necessary.

6.2 *Qualification*—In the case the adhesives for which the purchaser requires qualification, the procurement documents should state that the awards will be made only for adhesives that are qualified at the time set for opening of bids.

7. Test Requirements

7.1 *Material*—The adhesive shall be thermosetting and, when tested using the tests described in Section 8 shall meet the strength requirements of this specification. The adhesive

shall not have a detrimental effect on the surfaces being bonded over the range of temperatures at which the adhesives will be used.

7.2 *Qualification*—The adhesive shall be qualified at the time for opening of bids. The qualification shall only apply to the formulation on which the qualification tests have been made (see **6.2**). Any changes by the manufacturer in formulation or in the method of manufacturing, shall be cause of designating the adhesive as a new product.

7.3 *Processing*—Methods of specimen surface preparation, that is, cleaning and etching adherends, cure time, temperature and pressure shall be in accordance with the manufacturer's recommendation.

7.4 The physical, mechanical and outgassing properties of the adhesive shall meet the requirements specified in **Table 1**. Although, it is not listed in **Table 1**, Type II materials shall meet the same requirements as Type I materials.

8. Test Methods

8.1 *Qualification Tests*—For qualification, the adhesive shall be tested using the tests described in this section. Test methods and requirements are included in **Table 1**.

8.2 Preparation of Test Specimens:

8.2.1 Tensile Shear:

8.2.1.1 *Adherend*—The metal bonded shall be 6061-T6 or 2024-T3 aluminum alloy.

NOTE 3—The use of steel substrates for the evaluation and lot acceptance of the material is optional at the discretion of the procuring agency. Use Specification **A109/A109M** Grade 2 Steel or Specification **A167**, Type 302 corrosion resistant steel.

8.2.1.2 *Surface Treatment*—Adherend surfaces shall be cleaned and etched in accordance with Guide **D2651**.

8.2.1.3 *Cure*—Cure time, temperature and pressure shall be in accordance with the adhesive manufacturer's recommendation.

NOTE 4—Test panels or specimens, or both, other than the breakaway type shall be cut in such a manner that minimum vibration or heat is generated during the cutting operation.

NOTE 5—Adhesive bondline thickness for tensile shear specimens shall be 0.05 to 0.13 mm [0.002 in. to 0.005 in.] and 0.25 to 0.43 mm [0.010 to 0.017 in.] for T-Peel specimens. Control of bondline thickness shall be accomplished by placing two lengths of appropriate diameter stainless wire [0.13 mm for tensile shear and 0.43 mm for T-Peel] in the lengthwise direction on the specimen bond area during the adhesive bonding operation; the use of the same diameter glass beads approximately 0.5 % by weight, thoroughly mixed in the adhesive may also be used to maintain uniform bondline thickness.

8.2.2 Hardness specimens shall be prepared using a mixture of resin and catalyst for Type I Grades 1 or 2 in the ratios specified by the manufacturer or Type II premixed. Pour the thoroughly mixed material into an aluminum foil cup approximately 7.6 cm [3.0 in.] in diameter to a minimum thickness of 6.3 mm [0.25 in.]; cure per manufacturer's recommendation.

8.3 Test Procedures:

8.3.1 *Room-Temperature Tensile Shear*—Subject at least five specimens to a tensile shear test at normal temperature $25 \pm 3^{\circ}\text{C}$ [$77 \pm 5^{\circ}\text{F}$] in accordance with Test Method **D1002**.